Switch-mode Power Rectifiers

NHP820LFS, NRVHP820LFS

This LFPAK ultrafast rectifier provides fast switching performance with soft recovery in a compact thermally efficient package. The LFPAK package provides an excellent alternative to the DPAK, offering thermal performance nearly as good in a package occupying less than half the board space. Its low profile makes it a good option for flat panel display and other applications with limited vertical clearance. The device offers low leakage over temperature making it a good match for applications requiring low quiescent current.

Features

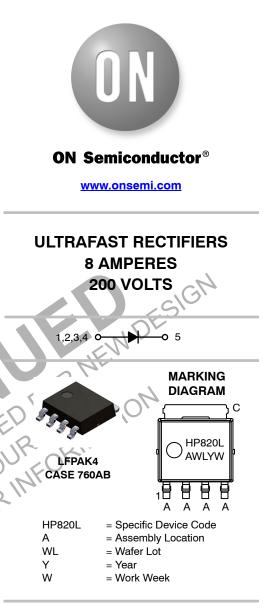
- New Package Provides Capability of Inspection and Probe After Board Mounting
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- Excellent Ability to Absorb Stresses Associated with Power Temperature Cycling
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

Applications

- Excellent Alternative to DPAK in Space–Constrained Automotive Applications
- Very Low Leakage for Higher Temperature Operation
- Output Rectification in Compact Portable Consumer Applications
- Freewheeling Diode used with Inductive Loads



ORDERING INFORMATION

Device	Package	Shipping†
NHP820LFST1G	LFPAK4 (Pb-Free)	3000 / Tape & Reel
NRVHP820LFST1G	LFPAK4 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Forward Current (Rated V _R , T_C = 168°C)	I _{F(AV)}	8.0	А
Peak Repetitive Forward Current, (Rated V_R , Square Wave, 20 kHz, $T_C = 158^{\circ}C$)	I _{FRM}	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	175	A
Storage Temperature Range	T _{stg}	–65 to +175	°C
Operating Junction Temperature	TJ	–55 to +175	°C
ESD Rating (Human Body Model)		3B	
ESD Rating (Machine Model)		C5	
Controlled Avalanche Energy (See Test Circuit in Figures 9 & 10)	W _{AVAL}	50	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. NEW

THERMAL CHARACTERISTICS

Characteristic	Symbol Max	Unit
Thermal Resistance, Junction-to-Ambient, Steady State (Assumes 645 mm ² 2 oz. copper bond pad, on a FR4 board)	R _{0JA} F 44N	°C/W
Thermal Resistance, Junction-to-Case, Steady State (Assumes 645 mm ² 2 oz. copper bond pad, on a FR4 board)	R _{ejc} ORMA 1.07	°C/W
ELECTRICAL CHARACTERISTICS	100, <u>F</u> O,	

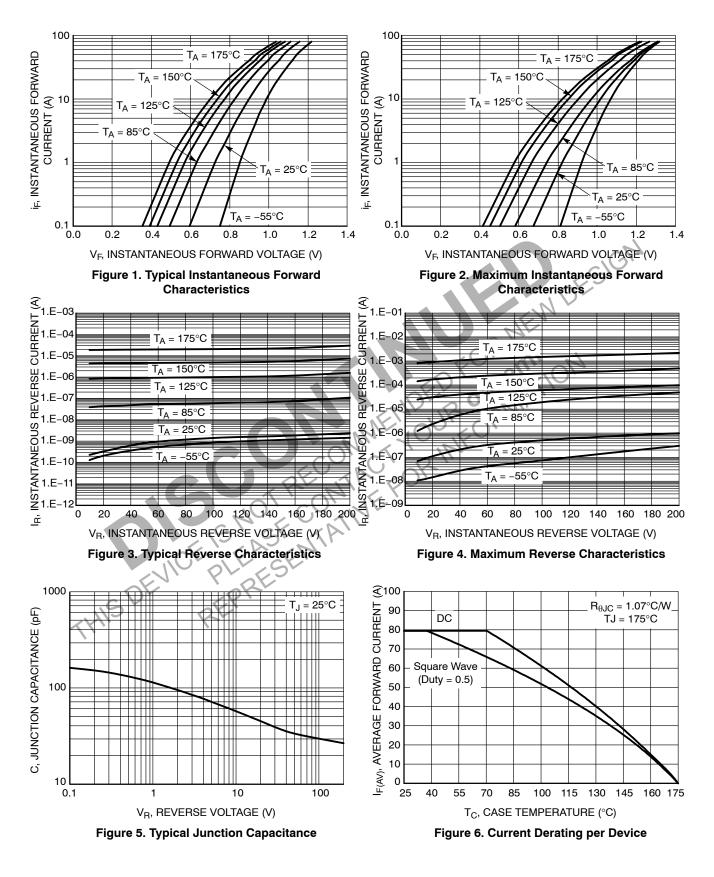
ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Instantaneous Forward Voltage (Note 1) ($i_F = 8 \text{ A}, T_J = 125^{\circ}\text{C}$) ($i_F = 8 \text{ A}, T_J = 25^{\circ}\text{C}$)	VF	0.88 1.00	V
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$)	İR	100 1.0	μΑ
Maximum Reverse Recovery Time (I _F = 1.0 A, di/dt = 50 A/µs, V _R = 30 V)	T _{rr}	35	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.

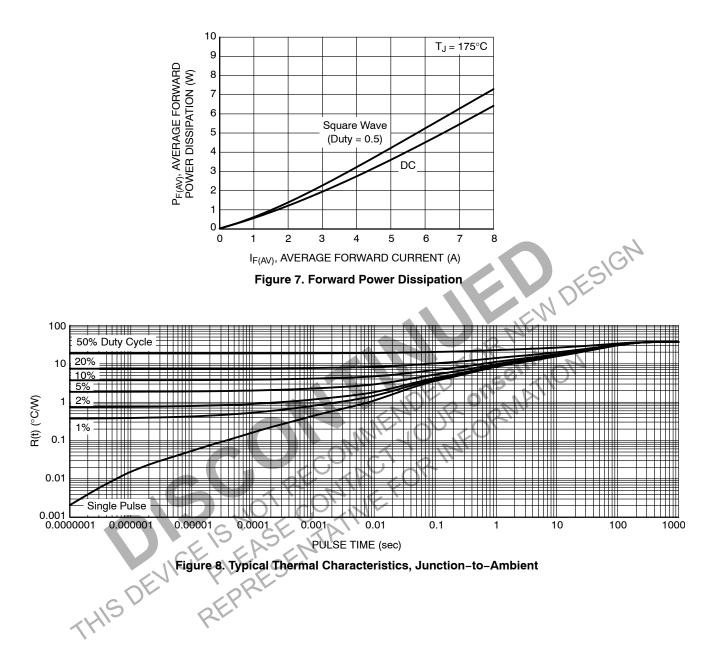
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TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS



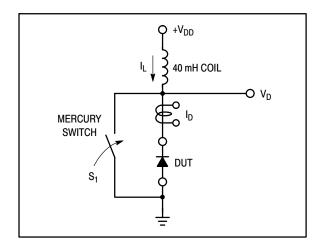


Figure 9. Test Circuit

The unclamped inductive switching circuit shown in Figure 9 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When S_1 is closed at t_0 the current in the inductor I_L ramps up linearly; and energy is stored in the coil. At t_1 the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at BV_{DUT} and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at t_2 .

By solving the loop equation at the point in time when S_1 is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V_{DD} power supply while the diode is in breakdown (from t_1 to t_2) minus any losses due to finite

THIST

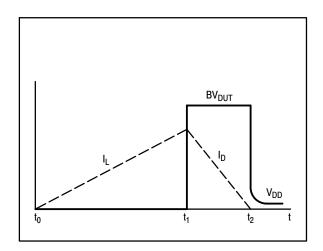


Figure 10. Current-Voltage Waveforms

component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the V_{DD} voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S₁ was closed, Equation (2).

EQUATION (1):

$$W_{AVAL} \approx \frac{1}{2} LI_{LPK}^{2} \left(\frac{BV_{DUT}}{BV_{DUT} - V_{DD}} \right)$$

EQUATION (2):

$$W_{AVAL} \approx \frac{1}{2} LI_{LPK}^2$$

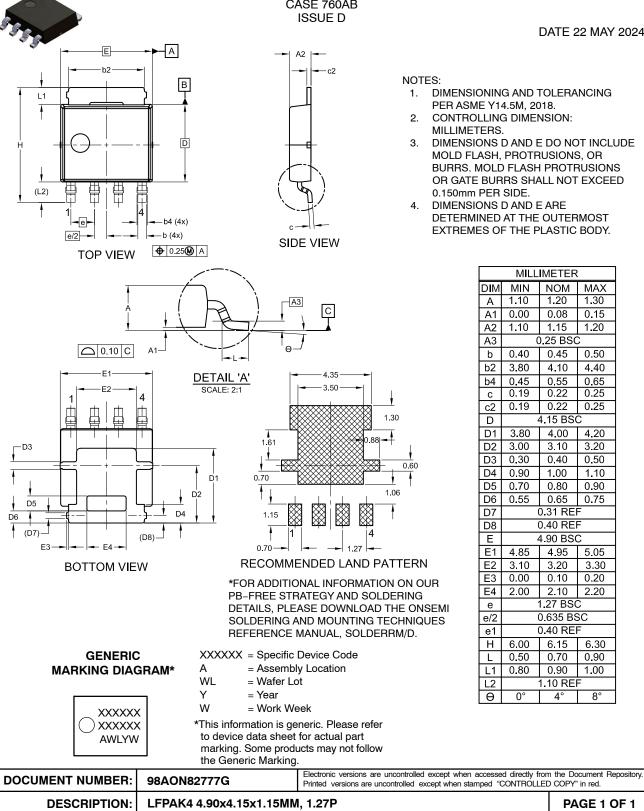
semi

LFPAK4 4.90x4.15x1.15MM, 1.27P CASE 760AB

DATE 22 MAY 2024

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS, MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.150mm PER SIDE.
- DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

MILLIMETER			
DIM	MIN	NOM	MAX
Α	1.10	1.20	1.30
A1	0.00	0.08	0.15
A2	1.10	1.15	1.20
A3	().25 BSC	2
b	0.40	0.45	0.50
b2	3.80	4.10	4.40
b4	0.45	0.55	0.65
С	0.19	0.22	0.25
c2	0.19	0.22	0.25
D	4 15 BSC		
D1	3.80	4.00	4.20
D2	3.00	3.10	3.20
D3	0.30	0.40	0.50
D4	0.90	1.00	1.10
D5	0.70	0.80	0.90
D6	0.55	0.65	0.75
D7	0.31 REF		
D8	0.40 REF		
Е	4.90 BSC		
E1	4.85	4.95	5.05
E2	3.10	3.20	3.30
E3	0.00	0.10	0.20
E4	2.00	2.10	2.20
е	1.27 BSC		
e/2	0.635 BSC		
e1	0.40 REF		
Н	6.00	6.15	6.30
L	0.50	0.70	0.90
L1	0.80	0.90	1.00
L2	1.10 REF		
θ	0°	4°	8°



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